

## N-Channel Enhancement Mode MOSFET

### 1. Product Information

#### 1.1 Features

- Advanced trench cell design
- Low Thermal Resistance

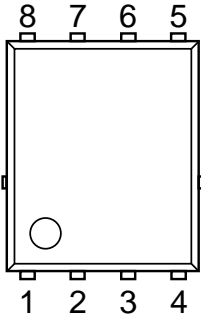
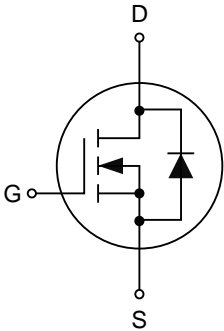
#### 1.2 Applications

- Motor drivers
- DC/DC Converter

#### 1.3 Quick reference

- $BV \geq 40\text{ V}$
- $R_{DS(ON)} \leq 2.8\text{ m}\Omega @ V_{GS} = 10\text{ V}$
- $P_{tot} \leq 78\text{ W}$
- $R_{DS(ON)} \leq 3.8\text{ m}\Omega @ V_{GS} = 4.5\text{ V}$
- $I_D \leq 120\text{ A}$

### 2. Pin Description

Pin	Description	Simplified Outline	Symbol
1,2,3	Source	 <p style="text-align: center;">Top View PDFN5x6-8L</p>	
4	Gate		
5,6,7,8	Drain		

## 3. Limiting Values

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DS</sub>	Drain-Source Voltage	T <sub>C</sub> =25°C	-	40	V
V <sub>GS</sub>	Gate-Source Voltage	T <sub>C</sub> =25°C	-	±20	V
I <sub>D</sub> <sup>*,***</sup>	Drain Current	T <sub>C</sub> =25°C, V <sub>GS</sub> =10 V	-	120	A
		T <sub>C</sub> =100°C, V <sub>GS</sub> =10 V	-	90	A
I <sub>DM</sub> <sup>*,**</sup>	Pulsed Source Current	T <sub>C</sub> =25°C, V <sub>GS</sub> =10 V	-	440	A
P <sub>tot</sub> <sup>*</sup>	Total Power Dissipation	T <sub>C</sub> =25°C	-	78	W
T <sub>J</sub> , T <sub>stg</sub>	Operating Junction and Storage Temperature Range		-55	150	°C
I <sub>S</sub>	Diode Forward Current	T <sub>C</sub> =25°C	-	120	A
E <sub>AS</sub> <sup>*</sup>	Single Pulsed Avalanche Energy	V <sub>DD</sub> =40 V, L=1.0 mH	-	312	mJ
R <sub>θJA</sub> <sup>*</sup>	Thermal Resistance-Junction to Ambient		-	56	°C/W
R <sub>θJC</sub> <sup>*</sup>	Thermal Resistance-Junction to Case		-	1.6	

Notes:

- \* Surface Mounted on 1 in<sup>2</sup> pad area, t ≤ 10 sec
- \*\* Pulse width ≤ 300 μs, duty cycle ≤ 2%
- \*\*\* Limited by bonding wire

## 4. Marking Information

Product Name	Marking
KJ2R8N04G	<div style="display: inline-block; background-color: black; color: white; padding: 2px;">2R8N04</div> <div style="display: inline-block; background-color: black; color: white; padding: 2px;">YWWXXX</div> <div style="display: inline-block; vertical-align: middle;">YWWXXX: Date Code</div>

## 5. Ordering Code

Product Name	Package	Reel Size	Tape width	Quantity	Note
KJ2R8N04G	PDFN5x6-8L	13 inches	-	5000	

Note: KUAJIEXIN defines "Green" as lead-free (RoHS compliant) and halogen free Br or Cl does not exceed 900 ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500 ppm by weight; Follow IEC 61249-2-21 and IPC/JEDEC J-STD-020C)

## 6. Electrical Characteristics (T<sub>A</sub>=25°C Unless Otherwise Noted)

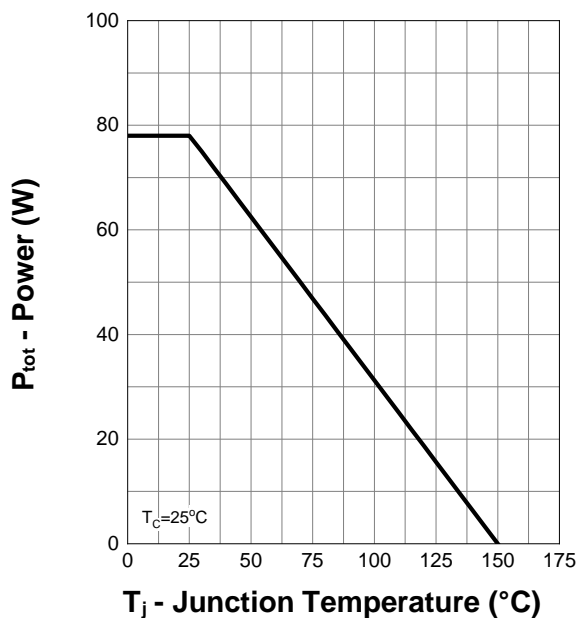
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Static Characteristics</b>						
B <sub>V</sub> DSS	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0 V, I <sub>DS</sub> =250 μA	40	-	-	V
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>DS</sub> =250 μA	1.0	-	2.0	V
I <sub>DSS</sub>	Drain Leakage Current	V <sub>DS</sub> =32 V, V <sub>GS</sub> =0 V	-	-	1	μA
I <sub>GSS</sub>	Gate Leakage Current	V <sub>GS</sub> =±20 V, V <sub>GS</sub> =0 V,	-	-	±100	nA
R <sub>DS(ON)</sub> <sup>a</sup>	On-State Resistance	V <sub>GS</sub> =10 V, I <sub>DS</sub> =20 A	-	2.5	2.8	mΩ
		V <sub>GS</sub> =4.5 V, I <sub>DS</sub> =10 A	-	3.5	3.8	mΩ
<b>Diode Characteristics</b>						
V <sub>SD</sub> <sup>a</sup>	Diode Forward Voltage	I <sub>SD</sub> =20 A, V <sub>GS</sub> =0 V	-	-	1.3	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>SD</sub> =20 A, V <sub>GS</sub> =0 V, dI <sub>SD</sub> /dt=100 A/μs	-	40	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	25	-	nC
<b>Dynamic Characteristics<sup>b</sup></b>						
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> =0 V, V <sub>DS</sub> =20 V, Frequency=1 MHz	-	2020	-	pF
C <sub>oss</sub>	Output Capacitance		-	84	-	
C <sub>rss</sub>	Reverse Transfer Capacitance		-	80	-	
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>DS</sub> =20 V, V <sub>GEN</sub> =10 V, R <sub>G</sub> =3.9 Ω, R <sub>L</sub> =1 Ω, I <sub>DS</sub> =20 A	-	9.2	-	ns
t <sub>r</sub>	Turn-on Rise Time		-	47	-	
t <sub>d(off)</sub>	Turn-off Delay Time		-	52	-	
t <sub>f</sub>	Turn-off Fall Time		-	40	-	
<b>Gate Charge Characteristics<sup>b</sup></b>						
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> =20 V, V <sub>GS</sub> =10 V, I <sub>DS</sub> =20 A	-	49	-	nC
Q <sub>gs</sub>	Gate-Source Charge		-	8.3	-	
Q <sub>gd</sub>	Gate-Drain Charge		-	10	-	

Notes:

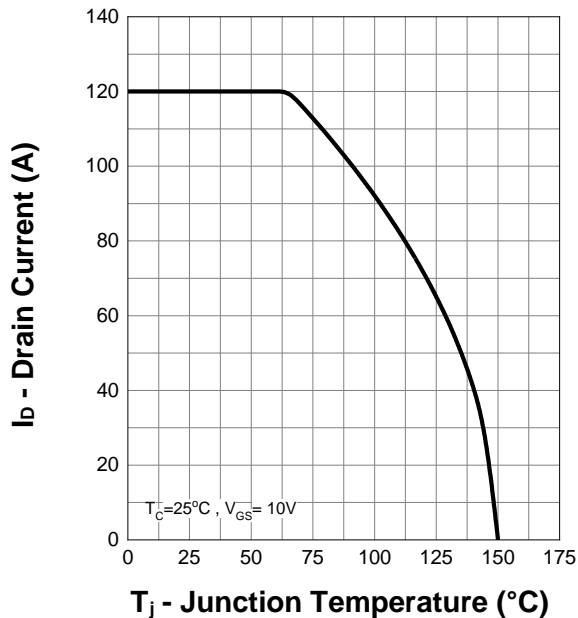
- Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%
- Guaranteed by design, not subject to production testing

## 7. Typical Characteristics

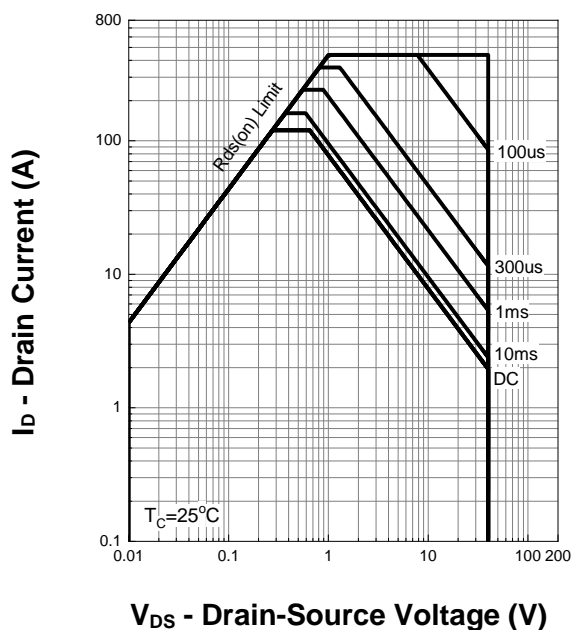
### Power Capability



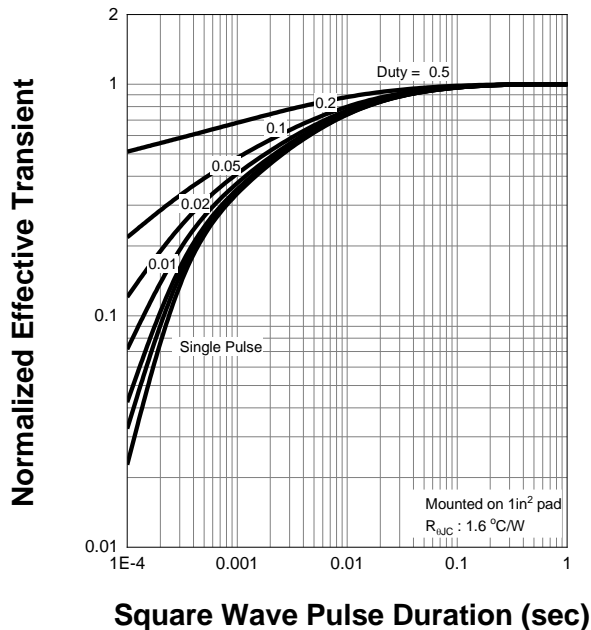
### Current Capability



### Safe Operating Area

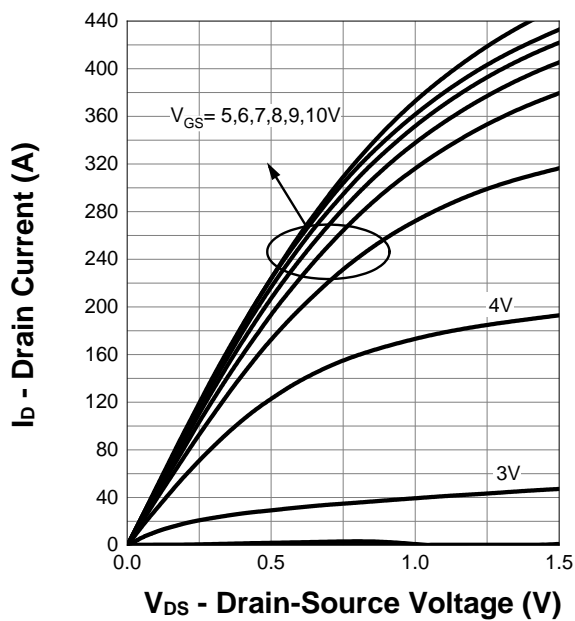


### Transient Thermal Impedance

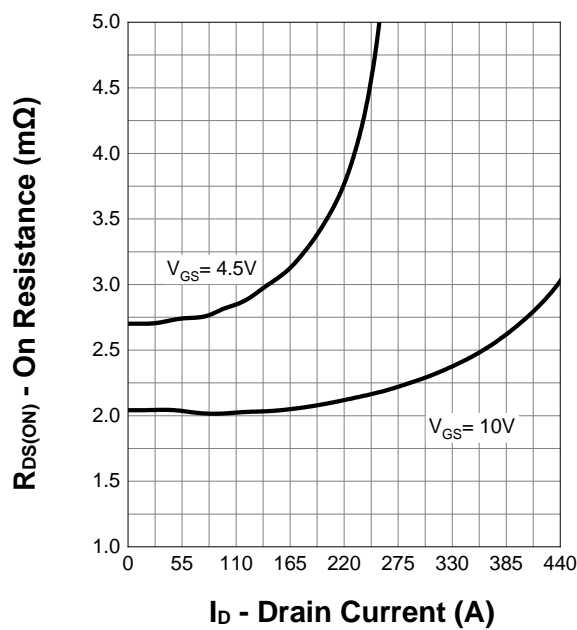


## 7. Typical Characteristics (Cont.)

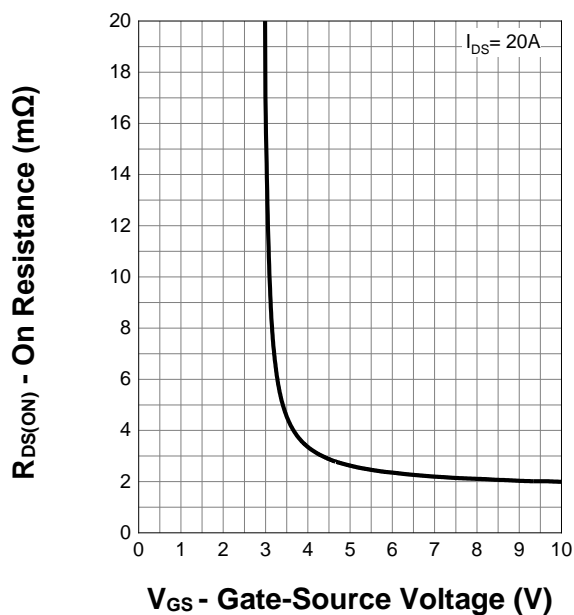
**Output Characteristics**



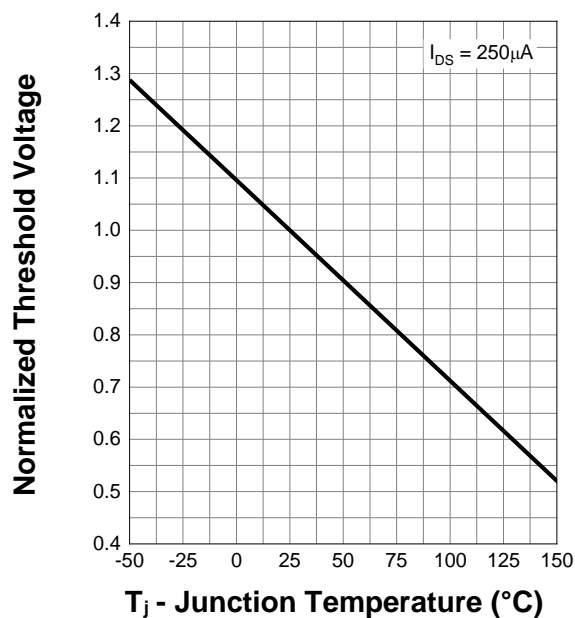
**On Resistance**



**Transfer Characteristics**

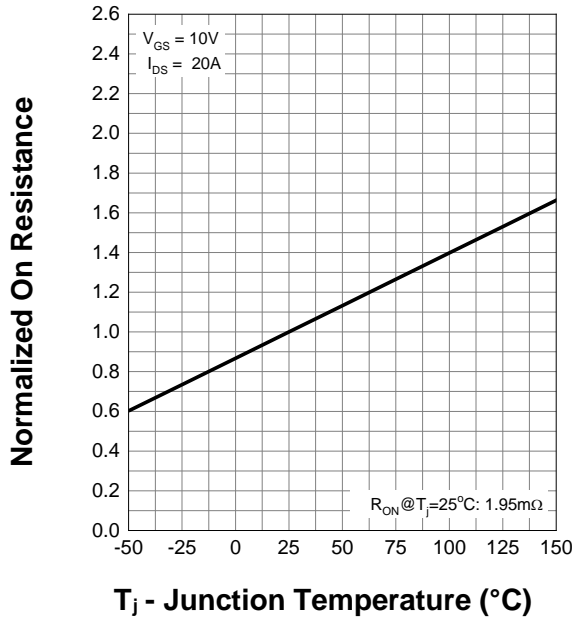


**Normalized Threshold Voltage**

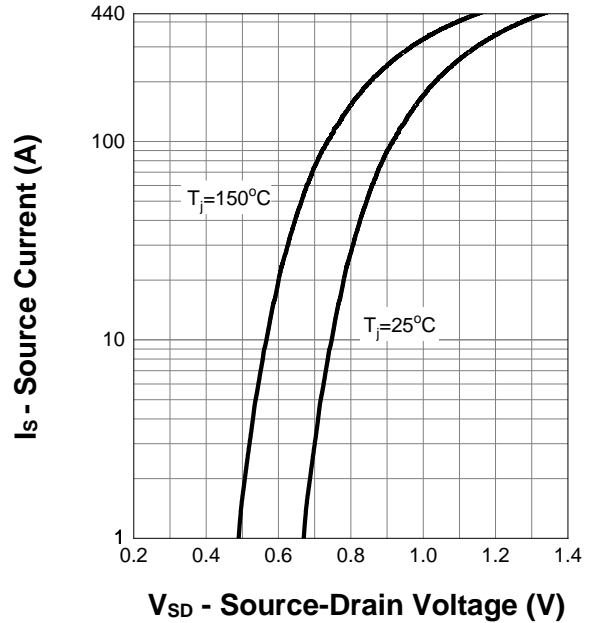


## 7. Typical Characteristics (Cont.)

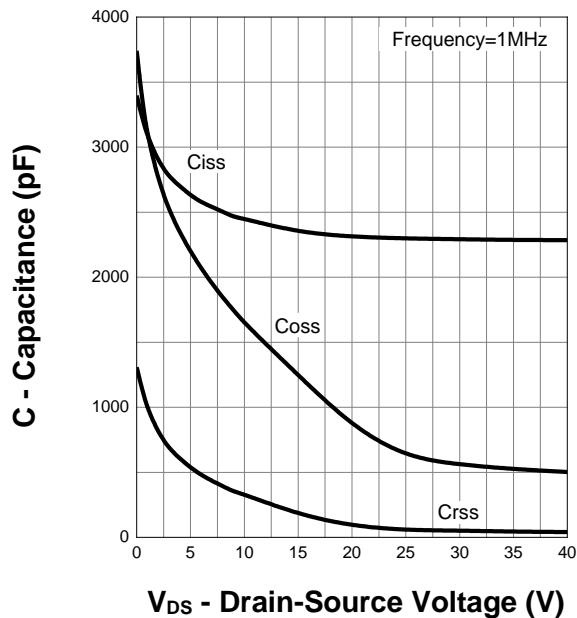
**Normalized On Resistance**



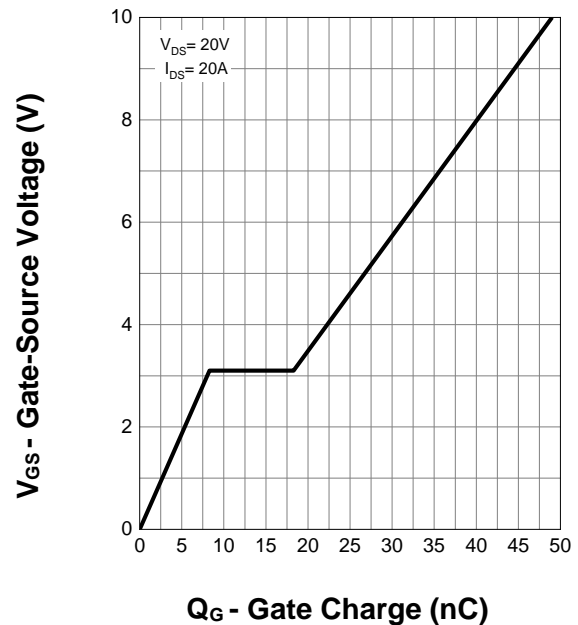
**Diode Forward Current**



**Capacitance**

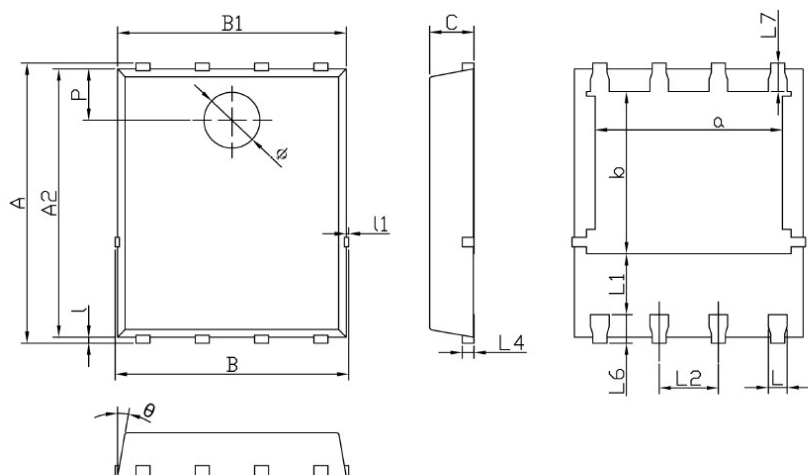


**Gate Charge**



## 8. Package Dimensions

### PDFN5x6-8L Package



Dimensions In Millimeterer			
Symbol	MIN	TYP	MAX
A	5.90	6.00	6.10
a	3.91	4.01	4.11
A2	5.70	5.75	5.80
B	4.90	5.00	5.10
b	3.37	3.47	3.57
B1	4.80	4.90	5.00
C	0.90	0.95	1.00
L	0.35	0.40	0.45
l	0.06	0.13	0.20
L1	1.10	-	-
l1	-	-	0.10
L2	1.17	1.27	1.37
L4	0.21	0.26	0.34
L6	0.51	0.61	0.71
L7	0.51	0.61	0.71
P	1.00	1.10	1.20
$\theta$	8°	10°	12°
$\phi$	1.10	1.20	1.30